Cooling reduction due to a rapid density decay of hot carriers in GaAs

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Abstract. The combined effect of a short carrier lifetime and of phonon emission on the cooling rate of nearly resonantly excited carriers in bulk GaAs has been investigated using picosecond time-resolved photoluminescence. Intense photoexcitation of carriers results in very short carrier density decay times of about 20 ps, leading to a considerable reduction of the cooling rate. The rapid density decay is attributed to a high stimulated recombination rate due to a high density accompanied by a low effective carrier temperature. Inclusion of the stimulated recombination in a model calculation for the energy relaxation by phonon emission leads to a significant recombination heating, which nicely explains the observed reduction of the carrier cooling rate.

1. Introduction

The influence of a finite carrier lifetime is generally neglected in the theoretical analysis of picosecond cooling curves of hot electron-hole plasmas [1]. However, when the carrier lifetime becomes comparable to the time during which the photoexcited carriers relax to the band extrema through phonon emission, the energy relaxation rate due to recombination can no longer be neglected. For degenerate Fermi-Dirac carrier distributions recombination may lead to carrier heating (recombination heating) [2], which has been observed experimentally in bulk GaAs [3, 4]. In this paper we will show, using a picosecond time- and energy-resolved photoluminescence (PL) technique, that under intense and nearly resonant excitation the carrier lifetime in GaAs is of the order of a few tens of picoseconds due to stimulated emission, resulting in a strongly reduced carrier cooling rate due to recombination heating.

2. Experimental details and results

The time-resolved PL experiments were carried out on two different samples, one grown by MBE, the other by MOVPE, each consisting of a 0.25 μm thick undoped GaAs layer sandwiched between two (Ga, Al)As layers [5]. Optical excitation at 1.69 eV was achieved with picosecond light pulses from a mode-locked Ti:sapphire laser, which were focused onto the sample surface to a 20 μm diameter spot. The laser time-averaged power ranged from $I_0/200$ to $I_0$ ($I_0 = 1.5$ kW cm$^{-2}$). The picosecond PL spectra were recorded using the up-conversion technique. The sample was kept at a temperature of 10 K [5].

Figure 1 shows typical measured PL spectra for two excitation densities (dotted curves). The full curves correspond to fits to the spectra calculated by the expression for band-to-band recombination, neglecting k-selection [6]:

$$r_{\text{rec}} = C \int f_e f_h g_e g_h \, dE,$$

where $f_{e,h}(g_{e,h})$ are the electron, hole Fermi-Dirac distribution (density of state) functions respectively. The coefficient C contains the optical matrix element and is related to the usual radiative recombination coefficient $B_r$ [6]. From this relatively simple lineshape analysis we obtain values for...
The inset in (6) shows the measured carrier density decay function of time after excitation (symbols). The full curves in Figure 2 shows the time evolutions of $n_{e,h}$ for the three lowest excitation levels. The computed curves for $n_{e,h}(t)$ agree very well with the experimental data for all values of the excitation intensity. However, for $T_{eh}(t)$ good agreement is only obtained for $T_{eh} > 60 \text{ K}$ and $20 < t < 60 \text{ ps}$, the regime where stimulated emission plays a dominant role. The rather high value of $\alpha (0.3)$ suggests that phonon heating does not particularly affect the cooling at times $> 20 \text{ ps}$ after nearly resonant excitation. For $t > 60 \text{ ps}$ the computed curves tend towards a final temperature of $\sim 40 \text{ K}$ which is the threshold for LO phonon emission. However, to describe the experimental $T_{eh}$, which decreases below 40 K for $t > 60 \text{ ps}$, we have to incorporate other scattering mechanisms into our model [5].

The influence of the very short carrier lifetime on the carrier cooling rate is clearly visible in figure 2(a) by comparison of $T_{eh}(t)$ for excitation intensities $I_0$ and $I_0/5$. A high $n_{e,h}$ after excitation. Since the electrons are created with an excess energy below the satellite valleys in the conduction band, the heating effect of electrons returning to the central valley [9] is negligible, leading to a relatively low $T_{eh}$. In a similar experiment in which electrons were created with similar densities, but much higher in the band, higher temperatures were found and no rapid density decay was observed [10].

3. Discussion

In order to calculate the full curves of figure 2 the radiative recombination rate, including stimulated recombination, is inserted into a model for the carrier cooling rates due to phonon emission [11]. We start from initial (experimental) values for $T_{eh}$ and $n_{e,h}$ from which the average carrier energy $\langle E \rangle$ is determined. After a time interval $\Delta t$ a new density $n'$ is calculated from the total recombination rate

$$n'_{e,h} = n_{e,h} - \Delta t \left( \int_0^{\infty} \mathrm{d}E \frac{n_{e,h}}{\tau_{eh}(E)} \right).$$

Subsequently the new average carrier energy $\langle E' \rangle$ is calculated

$$\langle E' \rangle = \frac{1}{n'_{e,h}} \left( \langle E \rangle n_{e,h} - \Delta t \left[ \left( \frac{\mathrm{d}E}{\mathrm{d}t} \right)_{\text{rec}} + \left( \frac{\mathrm{d}E}{\mathrm{d}t} \right)_{\text{eh}} \right] \right).$$

where $(\mathrm{d}E/\mathrm{d}t)_{\text{eh}}$ is the energy relaxation rate due to recombination of the carriers and $(\mathrm{d}E/\mathrm{d}t)_{\text{rec}}$ is the energy relaxation rate due to carrier-phonon interactions [11], including the polar optical (LO), non-polar optical deformation, piezoacoustic and acoustic deformation interactions of both electrons and holes. In front of the electron relaxation rate due to LO phonon scattering a phenomenological parameter $\alpha (\leq 1)$ [3] is used, to account for phonon heating [7,10].

From $n'$ and $\langle E' \rangle$ a new value for the effective carrier temperature at $t = \Delta t$ is calculated. For the subsequent time intervals this procedure is repeated. All curves of figure 2 were calculated with $\Delta t = 100 \text{ fs}$, $\alpha = 0.3$ and a recombination coefficient $B_e = 7 \times 10^{-9} \text{ cm}^3 \text{ s}^{-1}$ (at 77 K).

The computed curves for $n_{e,h}(t)$ agree very well with the experimental data for all values of the excitation intensity. However, for $T_{eh}(t)$ good agreement is only obtained for $T_{eh} > 60 \text{ K}$ and $20 < t < 60 \text{ ps}$, the regime where stimulated emission plays a dominant role. The rather high value of $\alpha (0.3)$ suggests that phonon heating does not particularly affect the cooling at times $> 20 \text{ ps}$ after nearly resonant excitation. For $t > 60 \text{ ps}$ the calculated curves tend towards a final temperature of $\sim 40 \text{ K}$ which is the threshold for LO phonon emission. However, to describe the experimental $T_{eh}$, which decreases below 40 K for $t > 60 \text{ ps}$, we have to incorporate other scattering mechanisms into our model [5].
At $t = 20 \text{ ps}$, $\Delta T_{\text{eff}} = T_{\text{eff}}(I_0) - T_{\text{eff}}(I_0/5) \approx 10 \text{ K}$, increases to $\Delta T_{\text{eff}} \approx 40 \text{ K}$ at $60 \text{ ps}$, and diminishes subsequently. Thus a reduced cooling rate appears for an excitation level $I_0$ with respect to $I_0/5$, just at those times where a considerable density decay rate is present, and which is well described by the model calculation. Hence, the observed reduction of the cooling rate can be attributed completely to the fast density decay rate, without further phonon heating effects.

Figure 3 illustrates the bare effect of a short carrier lifetime on the carrier cooling, and the relative importance of the contributing mechanisms. The full curve corresponds to the full curves in figure 2 for $I_0$ excitation. The broken curve corresponds to calculations in which $(d\delta/dt)_{\text{rec}}$ was omitted. The dotted curve was calculated by neglecting any recombination. Obviously in the case of no density decay (dotted curve). This reduction is the consequence of two effects:

(i) The rapid carrier density decay heats the carrier distribution, which is known as recombination heating [2, 3]. This effect originates from the first term on the right-hand side of equation (2): $\langle E' \rangle = (n/n') \langle E \rangle$, and is simulated by the chain curve in the inset of figure 3, calculated by omitting $(d\delta/dt)_{\text{rec}}$ for the experimentally observed carrier density decay for excitation level $I_0$. For our experimental parameters we deduce an enormous heating from 145 K to 800 K within 40 ps. These effects are considerably larger than the recombination heating discussed previously [2, 3], because of our exceptionally short carrier lifetimes of about 20 ps. However, due to the large LO phonon cooling rates no real heating is observed experimentally, but merely a reduction in the cooling rate.

(ii) Due to the rapid carrier recombination rate the loss of energy of the recombining carriers $(d\delta/dt)_{\text{rec}}$ forms an extra energy relaxation channel. Neglecting $(d\delta/dt)_{\text{rec}}$ in the calculations leads to the broken curves in figure 3. Comparison with the full curve proves that $(d\delta/dt)_{\text{rec}}$ enhances the cooling conspicuously and thus definitely cannot be neglected.

4. Conclusion

Nearly resonant excitation of hot carriers in GaAs results in an extraordinarily fast density decay which can be well explained by stimulated recombination. Consequently the radiative recombination rate has to be included in the analysis of the energy relaxation rate, since the short carrier lifetime leads to a considerable reduction of the carrier cooling by means of recombination heating, opposed partially by the extra loss of energy of the recombining carriers, which enhances the cooling rate.

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References
